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PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Frank Kuo	12/12/2011

RECEIVING PARTY DATA

Name:	Vishay-Siliconix	
Street Address:	2201 Laurelwood Road	
City:	Santa Clara	
State/Country:	CALIFORNIA	
Postal Code:	95054	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13229667

CORRESPONDENCE DATA

Fax Number: 4089389069

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: (408) 938-9060

Email: officeaction@mhbpatents.com
Correspondent Name: Murabito, Hao & Barnes LLP

Address Line 1: 2 N. Market Street

Address Line 2: 3rd Floor

Address Line 4: San Jose, CALIFORNIA 95113

ATTORNEY DOCKET NUMBER: VISH-8805

NAME OF SUBMITTER: Anthony C. Murabito

Total Attachments: 1

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PATENT REEL: 029163 FRAME: 0139 OF \$40.00 13ZZ966

Assignment to VISHAY-SILICONIX	Attorney Docket No.: VISH-8805
In consideration of good and valuable consideration, receipt of which Frank Kuo and Suresh Belani	
do hereby sell, assign, and transfer unto Vishay-Siliconix (here Corporation having its principal place of business at 2201 Laurely successors and assigns, the entire right, title, and interest for the Un any and all improvements, including the right of priority in, to, and patent entitled:	vood Road, Santa Clara, CA 95054, and its ited States and all foreign countries, in and to
DUAL LEAD FRAME SEMICONDUCTOR PACKAGE AND METHOD	OF MANUFACTURE
filed herewith and the inventions set forth and described therein, United States and of countries foreign thereto which may be gra	
X Serial No.: 13/229,667 filed on 09-09-2011 and described therein, and any and all Letters Patent of the Unwhich may be granted thereon or therefor;	and the inventions set forth nited States and of countries foreign thereto
And for the above consideration, I/we agree promptly upon request to execute and deliver without further compensation any power original, continuation, divisional or reissue, or other papers which may Vishay-Siliconix, its successors and assigns, the inventions descriptherein, in the United States and in any country foreign thereto, and interference proceedings involving said inventions and in the adjudic provided the expenses which may be incurred by me/us in lending to Vishay-Siliconix.	f attorney, assignment, application, whether by be necessary or desirable fully to secure to bed in said application and all patent rights to cooperate and assist in the prosecution of eation or reexamination of said Letters Patent
I/we further covenant with Vishay-Siliconix, its successors, assigns, a grant, mortgage, license, or other agreement affecting the rights and others by the undersigned, and that full right to convey the same undersigned;	property herein conveyed has been made to

Assignment to VISHAY-SILICONIX

do hereby sell, assign, and transfer unto Vishay-Siliconix (herein Corporation having its principal place of business at 2201 Laurelwo successors and assigns, the entire right, title, and interest for the Unite any and all improvements, including the right of priority in, to, and u patent entitled: DUAL LEAD FRAME SEMICONDUCTOR PACKAGE AND METHOD O filed herewith and the inventions set forth and described therein, a United States and of countries foreign thereto which may be gran X Serial No.: 13/229,667 filed on 09-09-2011 and described therein, and any and all Letters Patent of the Uni which may be granted thereon or therefor, And for the above consideration, I/we agree promptly upon request of to execute and deliver without further compensation any power of original, continuation, divisional or reissue, or other papers which may Vishay-Siliconix, its successors and assigns, the inventions describe therein, in the United States and in any country foreign thereto, and to interference proceedings involving said inventions and in the adjudical provided the expenses which may be incurred by me/us in lending su Vishay-Siliconix. I/we further covenant with Vishay-Siliconix, its successors, assigns, an grant, mortgage, license, or other agreement affecting the rights and p others by the undersigned, and that full right to convey the same undersigned; In witness whereof, I/we hereunto set my/our_hand(s) and seal: Inventor's Signature:

Date: 12, 20//

Frank Kuo Frank Kuo Inventor's Signature: Date: Suresh Belani

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